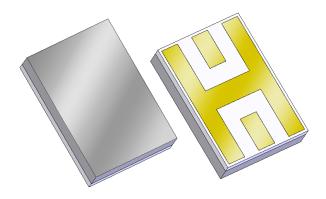


Applications

- For GPS L2 Applications
- For high-selectivity applications



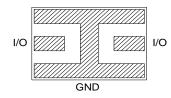
Product Features

- Usable bandwidth 25 MHz
- Low loss
- High selectivity
- Single-ended operation
- Ceramic chip-scale Package (CSP)
- Small Size
- Hermetic RoHS compliant, Pb-free

Pin Configuration

| Pin # SE-Balanced | Description |
|-------------------|--------------|
| I/O | Input/Output |
| GND | Ground |

Functional Block Diagram



Overall width, length, and thickness are the only critical dimensions. All other dimensions are for reference only.

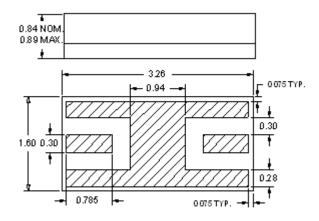
Dimensions shown are nominal in millimeters All tolerances are ± 0.13 mm except overall length and width ± 0.25 mm

Body: Sapphire
Package: Alumina
Terminations: Au plating 0.5 - 2.5μm, over a 2.0 – 6.0 μm Ni plating

Ordering Information

| Part No. | Description |
|-------------------|------------------|
| 880060 | packaged part |
| 880060 Eval Board | evaluation board |

- 1 of 6 -





Specifications

Electrical Specifications (1)

Specified Temperature Range: (2) -40 to +85 °C

| Parameter (3) | Conditions | Min | Typical ⁽⁴⁾ | Max | Units |
|-------------------------------------|------------------------------|--------|------------------------|--------|-------|
| | | | | | |
| Center Frequency | | - | 1227.6 | - | MHz |
| Maximum Insertion Loss | @ 1227.6 MHz | - | 1.8 | 2.5 | dB |
| 3dB Bandwidth | Reference loss at 1227.6 MHz | 25 | 30 | - | MHz |
| 20dB Lower Frequency Edge | | 1195.6 | 1200 | - | MHz |
| 20dB Upper Frequency Edge | | - | 1254 | 1259.6 | MHz |
| VSWR | @ 1227.6 MHz | - | 1.6 | 2.0 | - |
| Source Impedance (single-ended) (5) | | - | 50 | - | Ω |
| Load Impedance (single-ended) (5) | | - | 50 | - | Ω |

Notes

- 1. All specifications are based on the TriQuint schematic for the main reference design shown on page 3
- 2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature

- 2 of 6 -

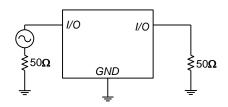
- 3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
- 4. Typical values are based on average measurements at room temperature
- 5. This is the optimum impedance in order to achieve the performance shown



Reference Design

Schematic



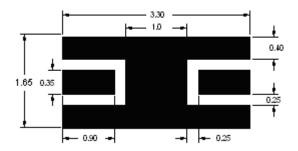


 $\begin{array}{c} 50~\Omega\\ \text{Single-ended}\\ \text{Input} \end{array}$

PC Board

Refer to **PCB Layout** for more information.

Mounting Configuration

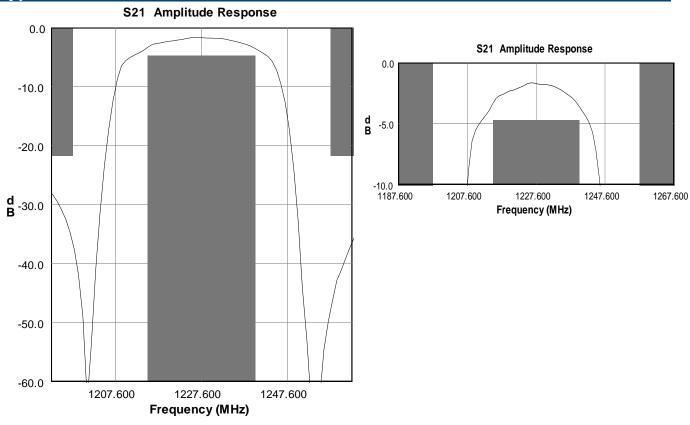


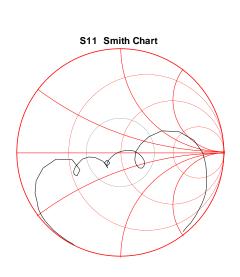
Notes:

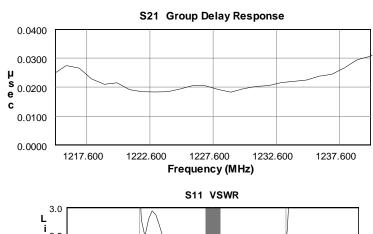
- 1. All dimensions are in millimeters.
- 2. This footprint represents a recommendation only.

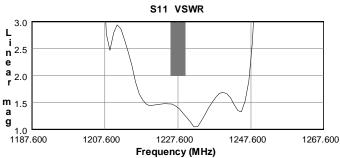


Typical Performance (at room temperature)





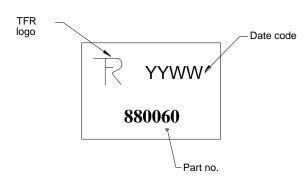






Mechanical Information

Marking



The date code consists of: YY = last digit of year, WW = 2 digit week

Tape and Reel Information

Tape and Reel available upon request EIA-481

Tinning available per J-STD-001

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Absolute Maximum Ratings

| Parameter | Rating |
|-----------------------|----------------|
| Operating Temperature | -40 to +85 °C |
| Storage Temperature | -55 to +100 °C |
| Maximum Input Power | +23 dBm |

Operation of this device outside the parameter ranges given above may cause permanent damage.



Product Compliance Information

ESD Information



Caution! ESD-Sensitive Device

Value: Passes ≥ 8000 V min.
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

Value: Passes \geq 1600 V min. Test: Machine Model (MM)

Standard: JEDEC Standard JESD22-A115

Refer to **ESD Sensitivity** for data

Solderability

Compatible with the latest version of J-STD-020, lead free solder, 260°C

Refer to **Soldering Profile** for recommended guidelines.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A $(C_{15}H_{12}Br_4O_2)$ Free
- PFOS Free
- SVHC Free

Contact Information

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